

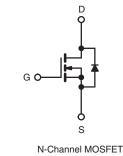
RoHS

COMPLIANT

Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	100			
R _{DS(on)} (Ω)	V _{GS} = 5.0 V 0.077			
Q _g (Max.) (nC)	64			
Q _{gs} (nC)	9.4			
Q _{gd} (nC)	27			
Configuration	Single			





FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Logic-Level Gate Drive
- R_{DS(on)} Specified at V_{GS} = 4 V and 5 V
- 175 °C Operating Temperature
- Fast Switching
- Ease of Paralleling
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRL540PbF
	SiHL540-E3
SnPb	IRL540
	SiHL540

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	100	v	
Gate-Source Voltage			V _{GS}	± 10		
Continuous Drain Current	V _{GS} at 5.0 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	- I _D	28		
	V _{GS} at 5.0 V	T _C = 100 °C		20	A	
Pulsed Drain Current ^a			I _{DM}	110		
Linear Derating Factor				1.0	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	440	mJ	
Avalanche Current ^a			I _{AR}	28	A	
Repetitive Avalanche Energy ^a			E _{AR}	15	mJ	
Maximum Power Dissipation	T _C = 25 °C		PD	150	W	
Peak Diode Recovery dV/dt ^c			dV/dt	5.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature)	for 10 s		-	300 ^d	U U	
Mounting Torque	6.00 or 1	0.00		10	lbf ∙ in	
Mounting Torque	6-32 or M3 screw			1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. V_{DD} = 25 V, starting T_J = 25 °C, L = 841 µH, R_g = 25 Ω , I_{AS} = 28 A (see fig. 12c).

c. $I_{SD} \le 28$ A, dI/dt ≤ 170 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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IRL540, SiHL540

Vishay Siliconix



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62		
Case-to-Sink, Flat, Greasd Surface	R _{thCS}	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1.0		

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	100	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C, I _D = 1 mA	-	0.12	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	- V _{GS} , I _D = 250 μΑ	1.0	-	2.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 10 V	-	-	± 100	nA
Zara Cata Valtaga Drain Current	1	V _{DS} =	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	25	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 80 V	, V _{GS} = 0 V, T _J = 150 °C	-	-	250	μA
Duain Course On State Desistance	D	$V_{GS} = 5.0 V$	I _D = 17 A ^b	-	-	0.077	Ω
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 4.0 \text{ V}$	I _D = 14 A ^b	-	-	0.11	
Forward Transconductance	9 _{fs}	V _{DS}	= 50 V, I _D = 17 A	12	-	-	S
Dynamic					•		
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$	-	2200	-	
Output Capacitance	C _{oss}		$V_{DS} = 25 V,$		560	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1.0 MHz, see fig. 5		-	140	-	
Total Gate Charge	Qg			-	-	64	
Gate-Source Charge	Q_gs	$V_{GS} = 5.0 V$	I _D = 28 A, V _{DS} = 80 V, see fig. 6 and 13 ^b	-	-	9.4	nC
Gate-Drain Charge	Q _{gd}	1		-	-	27	
Turn-On Delay Time	t _{d(on)}			-	8.5	-	-
Rise Time	t _r	Voo	= 50 V, I _D = 28 A,	-	170	-	
Turn-Off Delay Time	t _{d(off)}	$R_{\rm g} = 9.0 \ \Omega, R_{\rm D} = 1.7 \ \Omega, \text{ see fig. } 10^{\rm b}$		-	35	-	- ns
Fall Time	t _f	1			80	-	
Internal Drain Inductance	L _D	6 mm (0.25") f	Between lead, 6 mm (0.25") from		4.5	-	- nH
Internal Source Inductance	L _S	die contact		-	7.5	-	
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	showing the	MOSFET symbol showing the		-	28	A
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode		-	-	110	
Body Diode Voltage	V_{SD}	$T_J = 25 \ ^{\circ}C, \ I_S = 28 \ A, \ V_{GS} = 0 \ V^b$		-	-	2.5	V
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}, I_F = 28 \text{ A}, \text{ dl/dt} = 100 \text{ A/}\mu\text{s}^b$		-	200	260	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	1.7	2.90	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	-on is dor	ninated b	y L _S and	L _D)

Notes

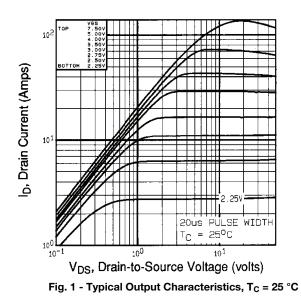
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

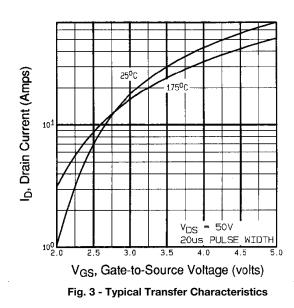
b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$

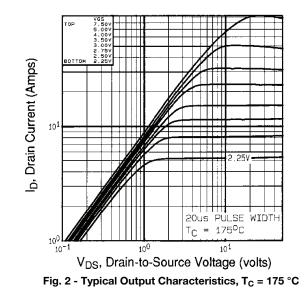
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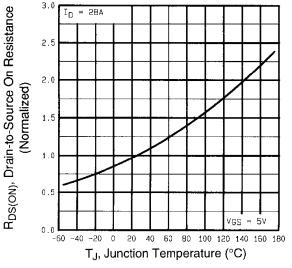


Fig. 4 - Normalized On-Resistance vs. Temperature

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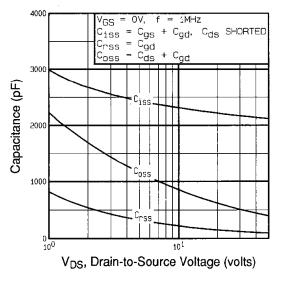
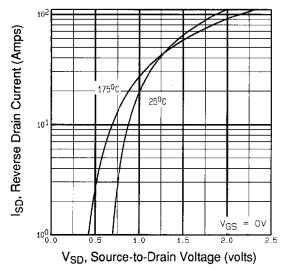
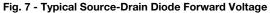


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





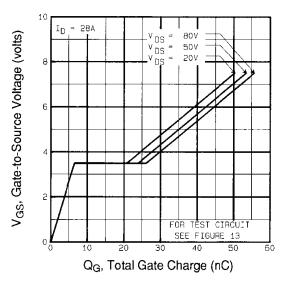
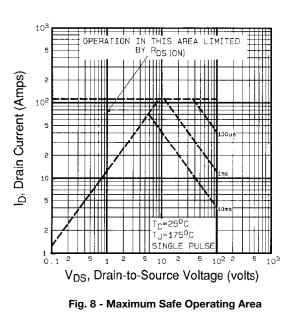


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



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IRL540, SiHL540

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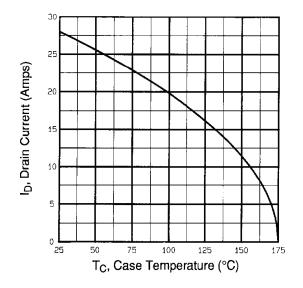


Fig. 9 - Maximum Safe Operating Area

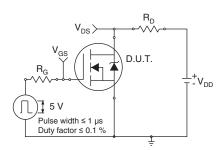


Fig. 10a - Switching Time Test Circuit

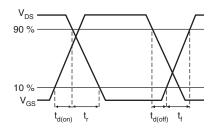


Fig. 10b - Switching Time Waveforms

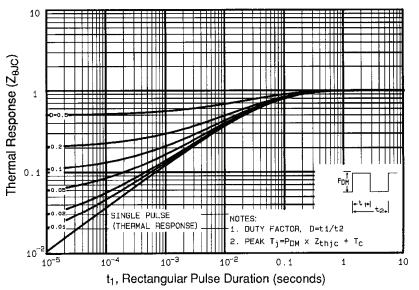


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



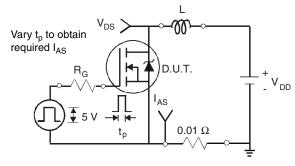


Fig. 12a - Unclamped Inductive Test Circuit

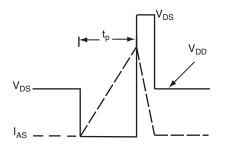


Fig. 12b - Unclamped Inductive Waveforms

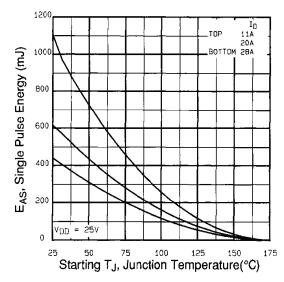
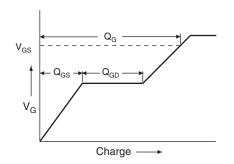


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





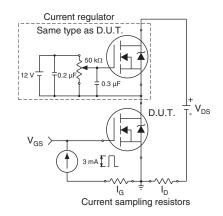
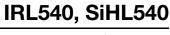


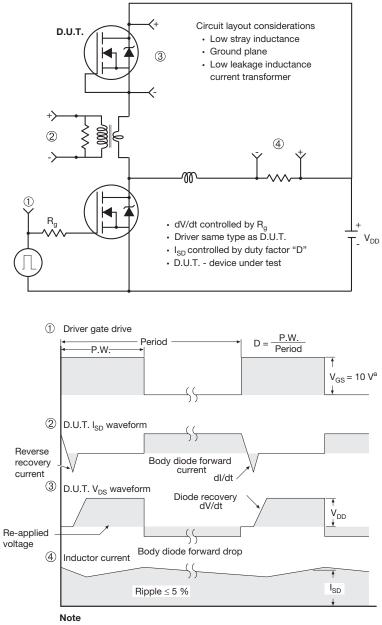
Fig. 13b - Gate Charge Test Circuit

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a. $V_{GS} = 5$ V for logic level devices

Fig. 14 - For N-Channel

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